

RoHS

COMPLIANT HALOGEN

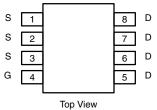
FREE

Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)			
100	0.0100 at V _{GS} = 10 V	19.7				
	0.0105 at V _{GS} = 7.5 V	19.2	27.9 nC			
	0.0120 at V _{GS} = 6.0 V	18				





Si4090DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

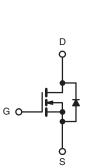
Ordering Information:

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % Rg and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC Primary Side Switch
- Telecom/Server
- Motor Drive Control
- Synchronous Rectification



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	v	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		19.7		
Continuous Drain Current (T $= 150$ °C)	T _C = 70 °C	1 , [15.8		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		13.2 ^{b, c}		
	T _A = 70 °C	1 [10.4 ^{b, c}	Α	
Pulsed Drain Current (t = 300 µs)		I _{DM}	70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		7		
	T _A = 25 °C	I _S	3.1 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30		
Avalanche Energy		E _{AS}	45	mJ	
	T _C = 25 °C		7.8		
Maximum Dawar Dissinction	T _C = 70 °C	1 , [5	w	
Maximum Power Dissipation	T _A = 25 °C	– P _D –	3.5 ^{b, c}	VV	
	T _A = 70 °C	1	2.2 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	29	35	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	13	16	0/11	

Notes:

a. Based on $T_C = 25$ °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•		•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050		67		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μΑ		- 6.4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		3.3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Oata Maltana Duain Ourreat	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А	
		V _{GS} = 10 V, I _D = 15 A		0.0080	0.0100		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 12 A		0.0085	0.0105		
		V _{GS} = 6.0 V, I _D = 10 A		0.0090	0.0120		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		54		S	
Dynamic ^b		•				L	
Input Capacitance	C _{iss}			2410		pF	
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		790			
Reverse Transfer Capacitance	C _{rss}			60			
Total Gate Charge		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		45.6	69		
	Q _g		27.9	42	1		
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_{D} = 10 \text{ A}$		8.5		nC	
Gate-Drain Charge	Q _{gd}			9.2			
Output Charge	Q _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$		63	95		
Gate Resistance	Rg	f = 1 MHz	0.4	1.3	2.6	Ω	
Turn-On Delay Time	t _{d(on)}			16	32		
Rise Time	t _r	V_{DD} = 50 V, R_L = 5 Ω		11	22		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 7.5 V, R_g = 1 Ω		35	70		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			14	28	ns	
Rise Time	t _r	V_{DD} = 50 V, R_L = 5 Ω		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 10 V, R_g = 1 Ω		36	70		
Fall Time	t _f			10	20		
Drain-Source Body Diode Characteristic	cs	•		•			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			7		
Pulse Diode Forward Current ^a	I _{SM}				70	A	
Body Diode Voltage	V _{SD}	I _S = 5 A		0.75	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			49	95	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			58	115	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		21			
Reverse Recovery Rise Time	t _b			28		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

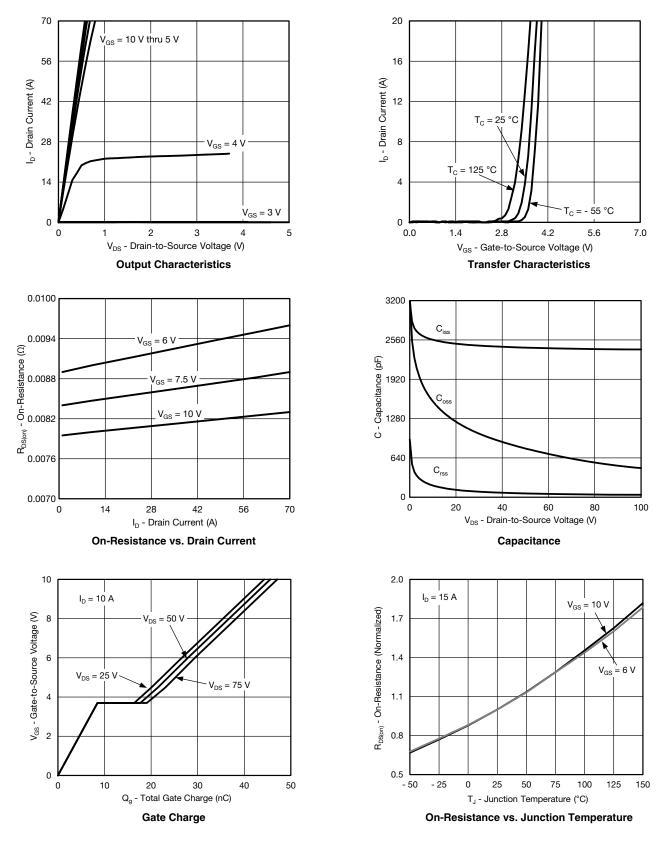
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $I_D = 5 \text{ mA}$

100

125

150

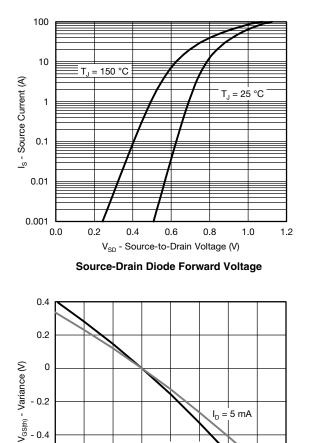
= 250 µA I_D

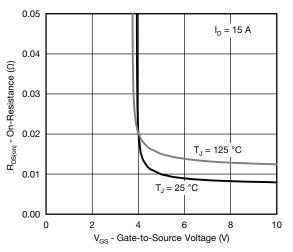
75

50

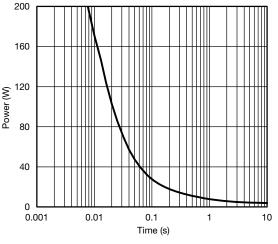
T_J - Temperature (°C)

Threshold Voltage

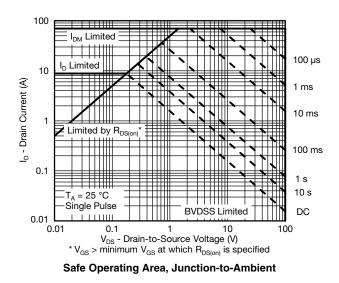




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



- 0.4

- 0.6

- 0.8

- 50

- 25

0

25

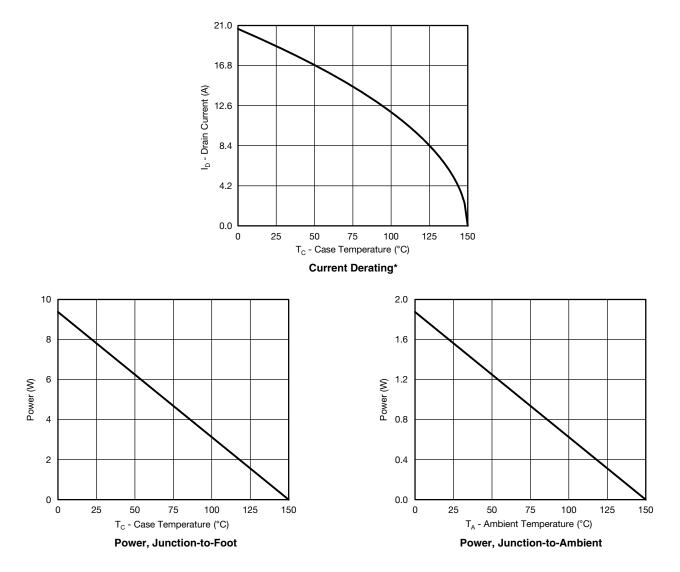
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Si4090DY Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

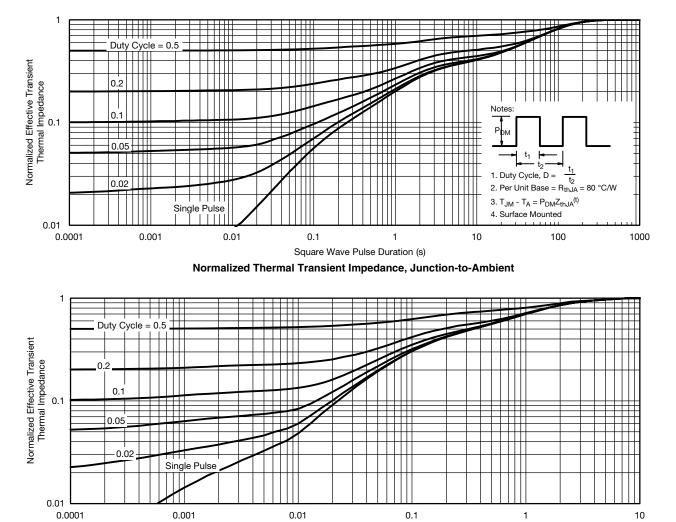


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63917.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





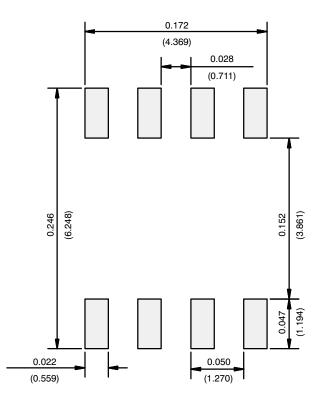
	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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